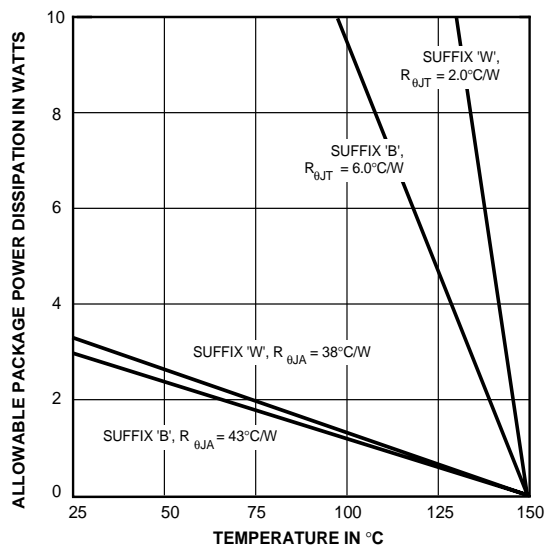
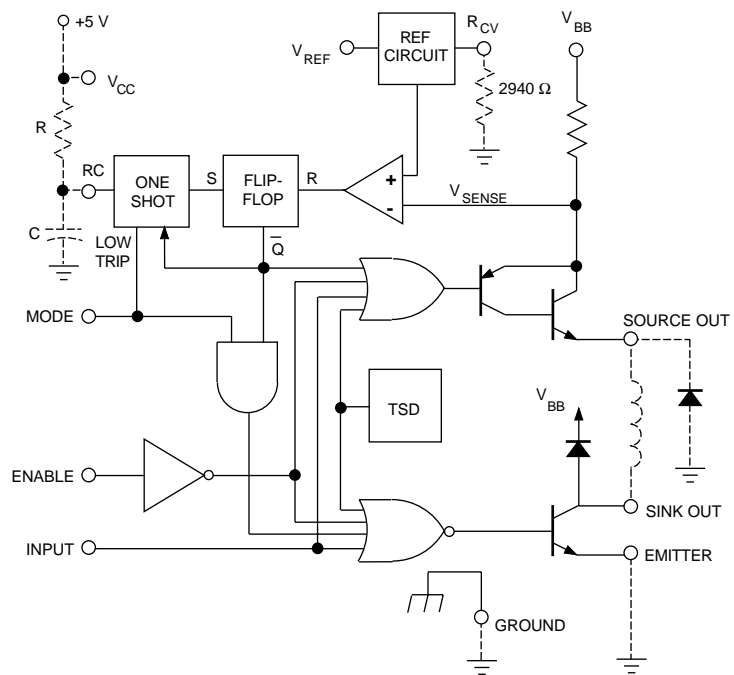


2961 HIGH-CURRENT HALF-BRIDGE PRINthead/MOTOR DRIVER



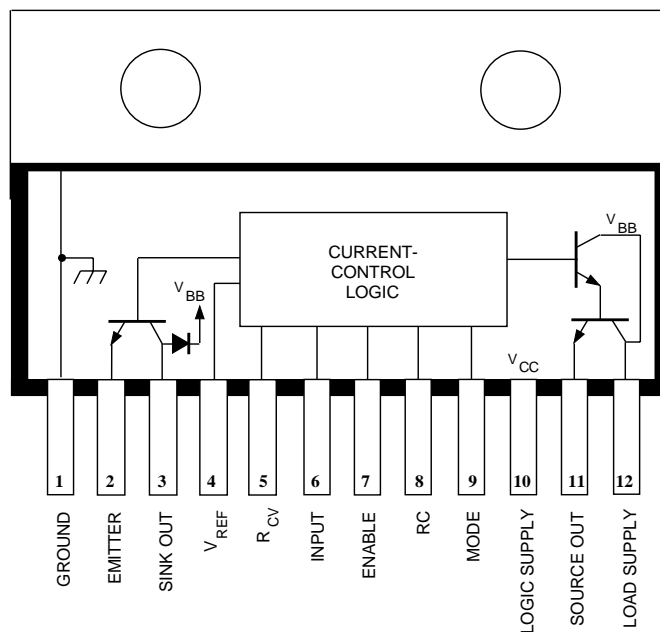
Dwg. GP-032A

FUNCTIONAL BLOCK DIAGRAM



Dwg. FP-019A

UDN2961W



Dwg. PP-036

2961

HIGH-CURRENT HALF-BRIDGE PRINthead/MOTOR DRIVER

ELECTRICAL CHARACTERISTICS at $T_A = +25^{\circ}\text{C}$, $V_{BB} = 45\text{ V}$,
 $V_{CC} = 4.75\text{ V}$ to 5.25 V , $R_{CV} = 2940\ \Omega$ (unless otherwise noted).

Characteristic	Symbol	Test Conditions	Limits			
			Min.	Typ.	Max.	Units

Output Drivers

Output Leakage Current	I_{CEX}	$V_{EN} = 0.8\text{ V}$, $V_{SOURCE} = 0\text{ V}$	—	<-1.0	-100	μA
		$V_{EN} = 0.8\text{ V}$, $V_{SINK} = 45\text{ V}$	—	<1.0	100	μA
Output Saturation Voltage	$V_{CE(SAT)}$	Source Driver, $I_{OUT} = -3.4\text{ A}$	—	1.6	2.2	V
		Source Driver, $I_{OUT} = -3.0\text{ A}$	—	1.5	—	V
		Sink Driver, $I_{OUT} = 3.4\text{ A}$	—	1.0	1.4	V
		Sink Driver, $I_{OUT} = 3.0\text{ A}$	—	0.9	—	V
Output Sustaining Voltage	$V_{CE(sus)}$	$I_{OUT} = \pm 3.4\text{ A}$, $L = 3\text{ mH}$	45	—	—	V
Recovery Diode Leakage Current	I_R	$V_R = 45\text{ V}$	—	<1.0	100	μA
Recovery Diode Forward Voltage	V_F	$I_F = 3.4\text{ A}$	—	—	2.0	V
Motor Supply Current	$I_{BB(on)}$	$V_{EN} = 2.0\text{ V}$, $V_{IN} = 0.8\text{ V}$, No Load	—	—	70	mA
	$I_{BB(off)}$	$V_{EN} = 0.8\text{ V}$	—	—	2.5	mA
Output Rise Time	t_r	Source Driver, $I_{OUT} = -3.4\text{ A}$	—	—	600	ns
		Sink Driver, $I_{OUT} = 3.4\text{ A}$	—	—	600	ns
Output Fall Time	t_f	Source Driver, $I_{OUT} = -3.4\text{ A}$	—	—	600	ns
		Sink Driver, $I_{OUT} = 3.4\text{ A}$	—	—	600	ns

Control Logic

Logic Input Voltage	$V_{IN(1)}$		2.0	—	—	V
	$V_{IN(0)}$		—	—	0.8	V
Logic Input Current	$I_{IN(1)}$	$V_{IN} = 5.0\text{ V}$	—	—	10	μA
	$I_{IN(0)}$	$V_{IN} = 0\text{ V}$	—	—	-1.0	mA
Reference Input Current	I_{REF}	$V_{REF} = 5.0\text{ V}$	—	—	50	μA
Transconductance	I_{TRIP}/V_{REF}	$V_{REF} = 1.0\text{ V}$	0.9	1.0	1.1	A/V
		$V_{REF} = 3.2\text{ V}$	0.9	1.0	1.1	A/V
Logic Supply Current	I_{CC}	$V_{EN} = 2.0\text{ V}$, $V_{IN} = 0.8\text{ V}$, No Load	—	—	160	mA
		$V_{EN} = 0.8\text{ V}$	—	—	15	mA
Turn On Delay	$t_{pd(on)}$	Source Driver	—	—	600	ns
		Sink Driver	—	—	600	ns
Turn Off Delay	$t_{pd(off)}$	Source Driver	—	—	2.0	μs
		Sink Driver	—	—	2.0	μs
Thermal Shutdown Temperature	T_J		—	165	—	$^{\circ}\text{C}$

Negative current is defined as coming out of (sourcing) the specified device terminal.

2961 HIGH-CURRENT HALF-BRIDGE PRINthead/MOTOR DRIVER

APPLICATIONS INFORMATION

The UDN2961B/W is a high current half-bridge designed to drive a number of inductive loads such as printer solenoids, stepper motors, and dc motors. Load current is sensed internally and is controlled by pulse-width modulating (PWM) the output driver(s) in a fixed off-time, variable-frequency format. The peak current level is set by the user's selection of a reference voltage. A slow current-decay mode (chopping only the source driver) or a fast current-decay mode (chopping both the source and sink drivers) can be selected via the MODE pin.

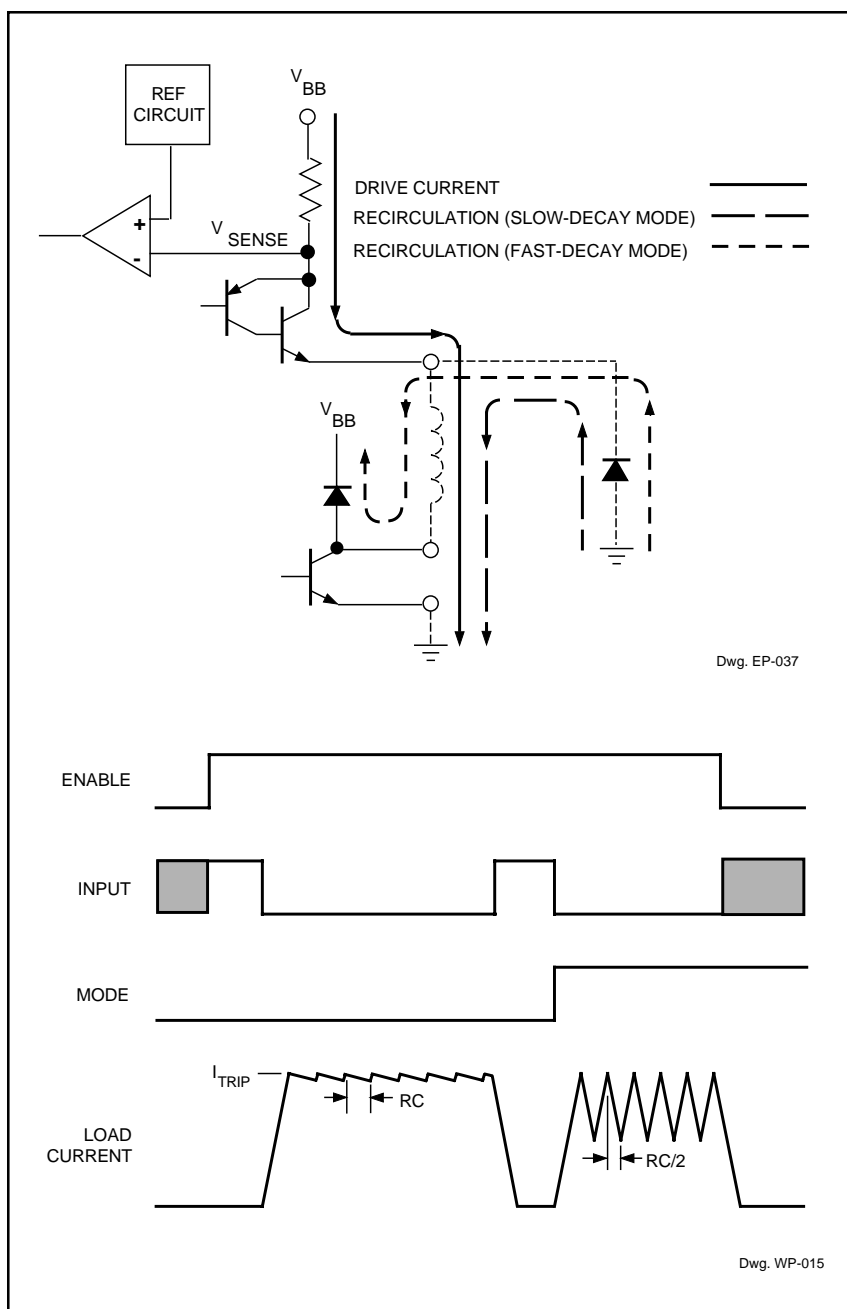
PWM CURRENT CONTROL

A logic low on the MODE pin sets the current-control circuitry into the slow-decay mode. The RS flip-flop is set initially, and both the source driver and the sink driver are turned ON when the INPUT pin is at a logic low. As current in the load increases, it is sensed by the internal sense resistor until the sense voltage equals the trip voltage of the comparator. At this time, the flip-flop is reset and the source driver is turned OFF. Over the range of $V_{REF} = 0.8\text{ V}$ to 3.4 V , the output current trip point transfer function is a direct linear function of the reference voltage:

$$I_{TRIP} = V_{REF}$$

To ensure an accurate chop current level ($\pm 10\%$), an external $2940\ \Omega \pm 1\%$ resistor (R_{CV}) is used. The actual load current peak will be slightly higher than the trip point (especially for low-inductance loads) because of the internal logic and switching delays (typically $1.5\ \mu\text{s}$). After the source driver turns OFF, the load current decays, circulating through an external ground clamp diode, the load, and the sink transistor. The source driver's OFF time (and therefore the magnitude of the current decrease) is determined by the one-shot's external RC timing components:

$$t_{OFF} = RC$$



within the range of $20\text{ k}\Omega$ to $100\text{ k}\Omega$ and 100 pF to 1000 pF . When the one-shot times out, the flip-flop is set again, the source driver is re-enabled, and the load current again is allowed to rise to the set peak value and trip the comparator. This cycle repeats itself, maintaining the average load current at the desired level.

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HIGH-CURRENT HALF-BRIDGE PRINthead/MOTOR DRIVER

A logic high on the MODE pin sets the current-control circuitry into the fast-decay mode. When the peak current threshold is detected, the flip-flop is reset and both the source driver and the sink driver turn OFF. Load current decays quickly through the external ground clamp diode, the load, and the internal flyback diode. In the fast-decay mode, the OFF time period is one-half the time that is set by the external RC network for the slow-decay mode:

$$t_{OFF} = \frac{RC}{2}$$

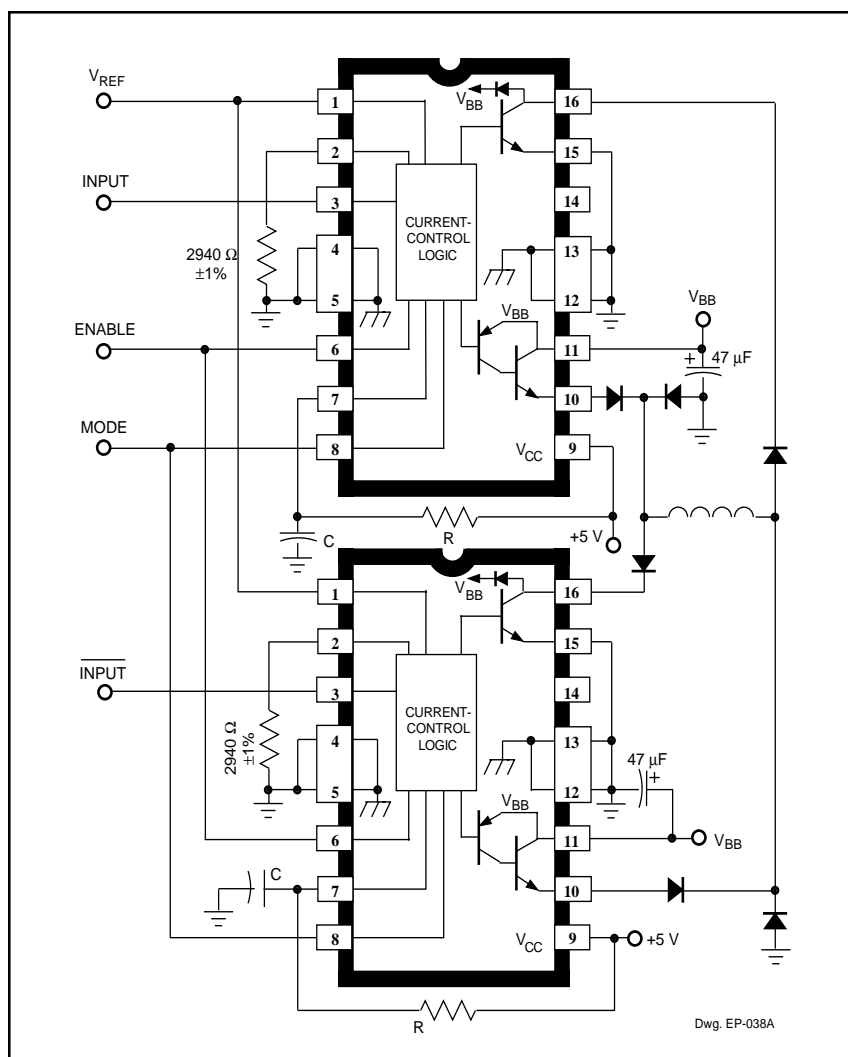
The amount of ripple current, when chopping in the fast-decay mode, is considerably higher than when chopping in the slow-decay mode.

The frequency of the PWM current control is determined by the time required for the load current to reach the set peak threshold (a function of the load characteristics and V_{BB}) plus the OFF time of the switching driver(s) (set by the external RC components).

To prevent false resetting of the flip-flop, due to switching transients and noise, a blanking time for the comparator can be set by the user where $t_B \approx 3600 \times C$ in the slow-decay mode or $t_B \approx 2400 \times C$ in the fast-decay mode. For C between 100 pF and 1000 pF, t_B is in μs .

POWER CONSIDERATIONS

The UDN2961B/W outputs are optimized for low power dissipation. The sink driver has a maximum saturation voltage drop of only 1.4 V at 3.4 A, while the source driver has a 2.2 V drop at -3.4 A. Device power dissipation is minimized in the slow-decay mode, as the chopping driver (the source driver) is ON for less than 50% of the chop period. When the source driver is OFF during a chop cycle, power is dissipated on chip only by the sink driver; the rest of the power is dissipated through the external ground clamp diode. In the fast-decay mode, the ON time of the chopping drivers (both the source driver



and the sink driver) may be greater than 50%, and the power dissipation will be greater.

GENERAL

A logic low on the ENABLE pin prevents the source driver and the sink driver from turning ON, regardless of the state of the INPUT pin or the supply voltages. With the ENABLE pin high, a logic low on the INPUT pin turns ON the output drivers.

To protect against inductive load voltage transients, an external ground clamp diode is required. A fast-recovery diode is recommended to reduce power dissipation in the UDN2961B/W. The blanking time prevents false triggering of the current sense comparator, which can be caused by the recovery current spike of the ground clamp diode when the chopping source driver turns ON.

2961 HIGH-CURRENT HALF-BRIDGE PRINthead/MOTOR DRIVER

The load supply (V_{BB}) should be well decoupled with a capacitor placed as close as possible to the device.

The EMITTER pin should be connected to a high-current power ground.

Thermal shutdown protection circuitry is activated and turns OFF both output drivers at a junction temperature of typically +165°C. It is intended only to protect the device from catastrophic failures due to excessive junction temperatures and should not imply that output short circuits are permitted. The output drivers are re-enabled when the junction temperature cools down to approximately +145°C.

MOTOR DRIVER APPLICATIONS

Two UDN2961B/Ws can be cross connected as shown to form a full-bridge driver circuit. Two full-bridge circuits are needed to drive a two-phase bipolar stepper motor. When in a full-bridge configuration, one INPUT signal must be logically inverted from the other INPUT signal to prevent the simultaneous conduction of a source driver from one half-bridge and the sink driver from the other half-bridge. In order to prevent crossover currents, a turn-ON delay time of 3 μ s is needed between the time an INPUT signal for one of the half bridges goes high and the INPUT signal for the other half bridge goes low.

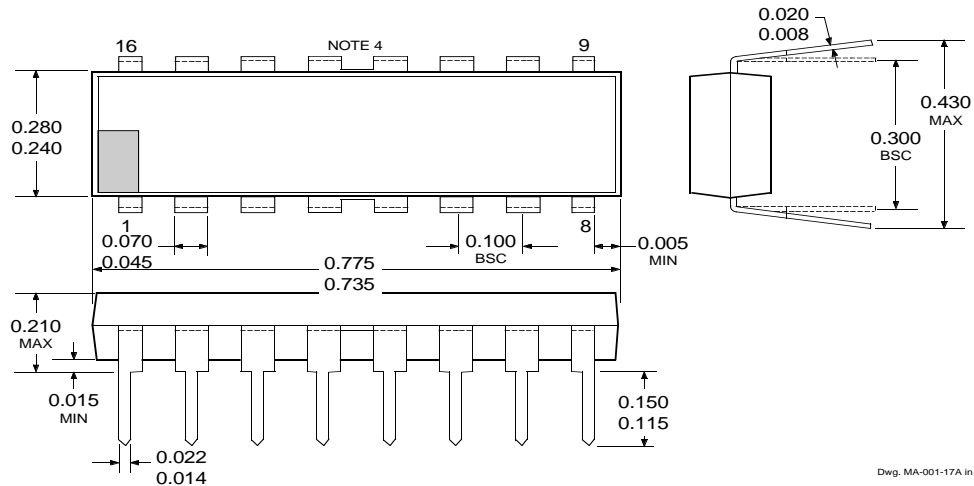
In addition to the two external ground clamp diodes, diodes in series with the load to the SINK OUT are needed in a full-bridge configuration. These series diodes prevent the sink drivers from conducting on the inverse mode, which can occur when the opposite half-bridge ground clamp diode is conducting and forces the sink driver collector below ground.

If fast current decay is used (MODE = logic high) or pulse width modulation of the load-current direction is used, diodes in series with the load to the SOURCE OUT are needed. These series diodes prevent the SOURCE OUT from inverse conducting during the recirculation period and thereby prevent shoot-through currents from occurring as the drivers turn back ON.

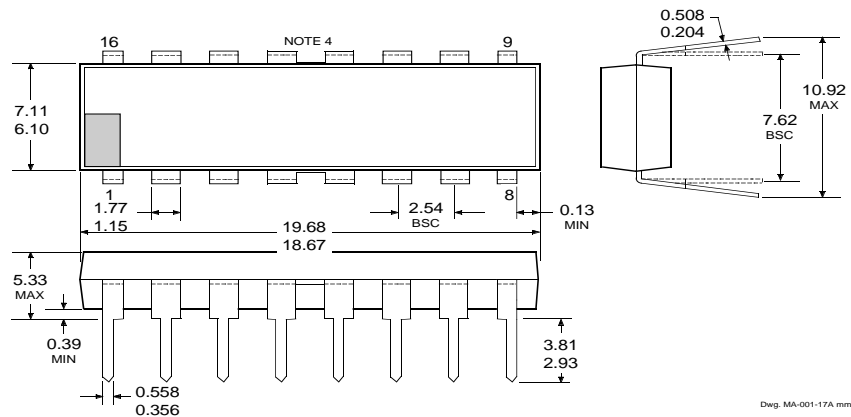
2961 HIGH-CURRENT HALF-BRIDGE PRINthead/MOTOR DRIVER

UDN2961B

Dimensions in Inches
(controlling dimensions)



Dimensions in Millimeters
(for reference only)

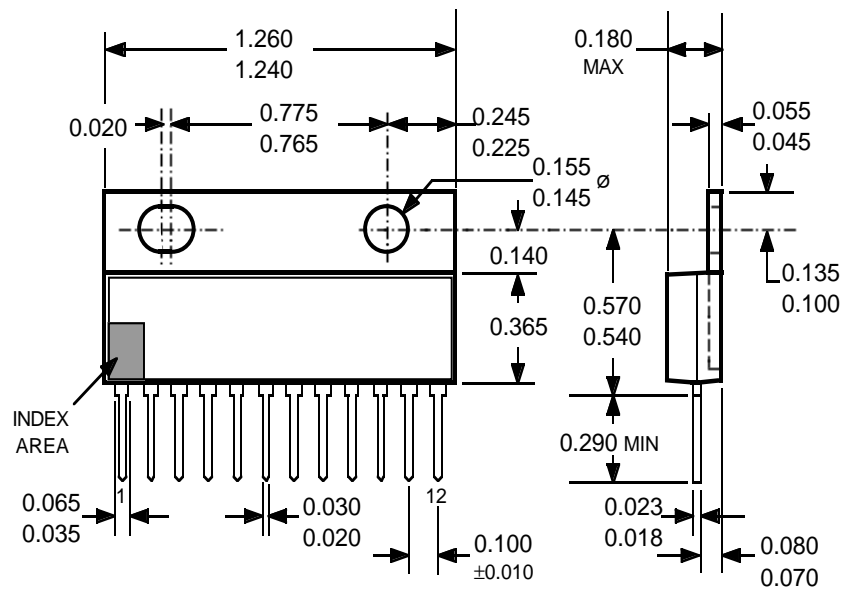


- NOTES:
1. Exact body and lead configuration at vendor's option within limits shown.
 2. Lead spacing tolerance is non-cumulative
 3. Lead thickness is measured at seating plane or below.
 4. Webbed lead frame. Leads 4, 5, 12, and 13 are internally one piece.

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HIGH-CURRENT
HALF-BRIDGE
PRINthead/MOTOR DRIVER

UDN2961W

Dimensions in Inches
(controlling dimensions)



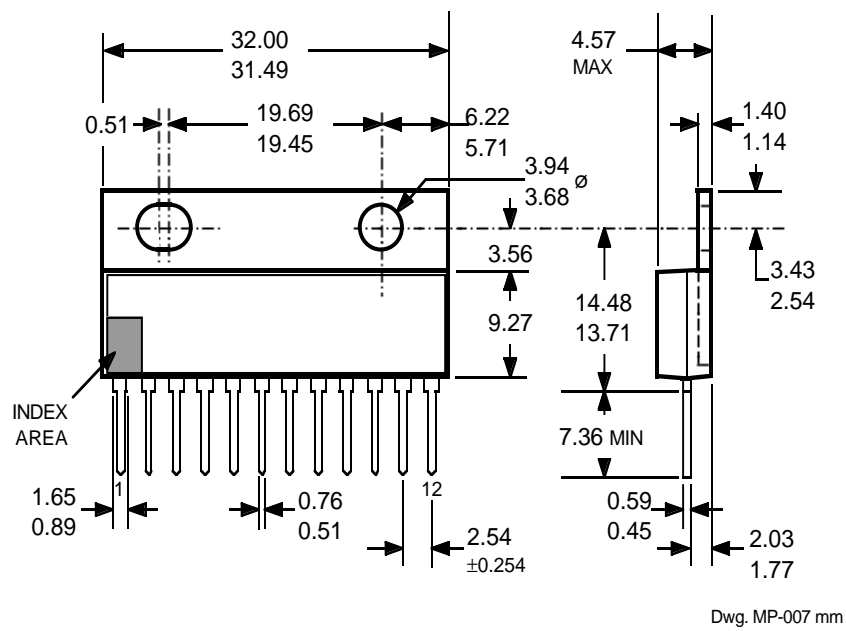
Dwg. MP-007 in

- NOTES: 1. Lead thickness is measured at seating plane or below.
2. Lead spacing tolerance is non-cumulative
3. Exact body and lead configuration at vendor's option within limits shown.
4. Lead gauge plane is 0.030" below seating plane.

2961
HIGH-CURRENT
HALF-BRIDGE
PRINTHEAD/MOTOR DRIVER

UDN2961W

Dimensions in Millimeters
(for reference only)



- NOTES:
1. Lead thickness is measured at seating plane or below.
 2. Lead spacing tolerance is non-cumulative
 3. Exact body and lead configuration at vendor's option within limits shown.
 4. Lead gauge plane is 0.762 mm below seating plane.

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HIGH-CURRENT
HALF-BRIDGE
PRINthead/MOTOR DRIVER

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